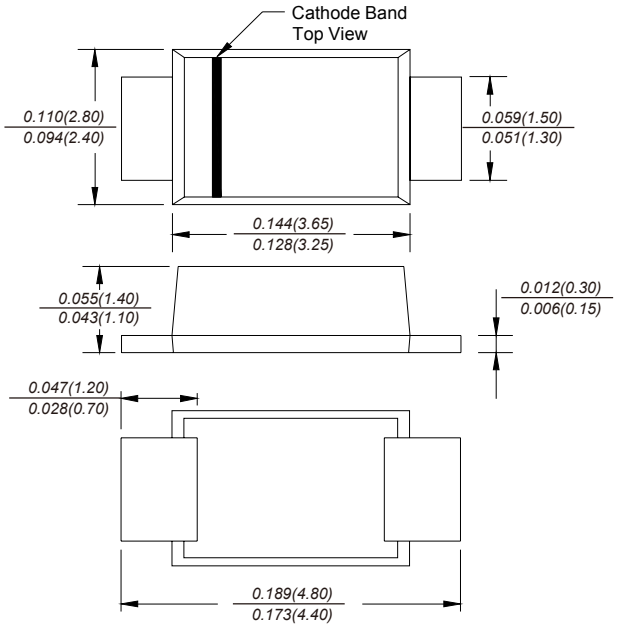
ES2AF THRU ES2JF

2.0 AMPS. Surface Mount Super Fast Recovery Rectifiers

FEATURES

The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
For surface mounted applications
Ultra fast switching for high efficiency
Low reverse leakage
Built-in strain relief,ideal for automated placement
High forward surge current capability
High temperature soldering guaranteed
260°C/10 seconds at terminals
Glass passivated chip junction

SMAF



Dimensions in inches and (millimeters)

MECHANICAL DATA

Case: SMAF molded plastic body over passivated chip
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight:0.0014 ounce, 0.038grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25℃ ambient temperature unless otherwise specified.
Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

	SYMBOLS	ES2AF	ES2BF	ES2CF	ES2DF	ES2EF	ES2GF	ES2JF	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current at T_L=75℃	$I_{(AV)}$	2.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	50.0							A
Maximum instantaneous forward voltage at 2.0A	V_F	0.95				1.25		1.7	V
Maximum DC reverse current T_A=25℃ at rated DC blocking voltage T_A=100℃	I_R	5.0 50.0							μA
Maximum reverse recovery time	t_{rr}	35							ns
Typical junction capacitance	C_J	60.0							pF
Typical thermal resistance	$R_{\theta JA}$	65.0							°C/W
Operating junction and storage temperature range	T_J,T_{STG}	-55 to +150							°C

Note:1.Reverse recovery condition I_F=0.5A,I_R=1.0A,Irr=0.25A
2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

FIG. 1- FORWARD CURRENT DERATING CURVE

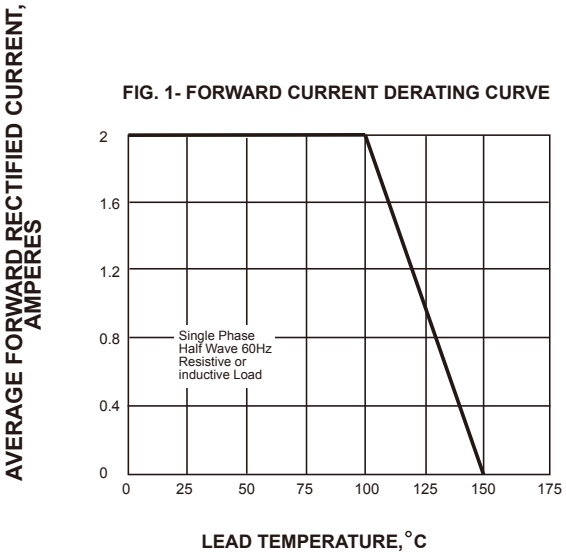


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

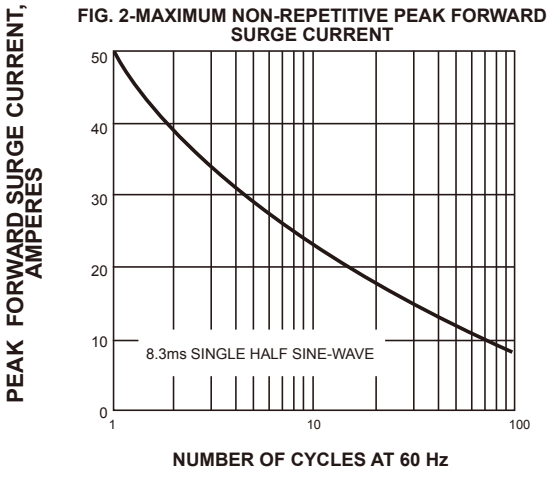


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

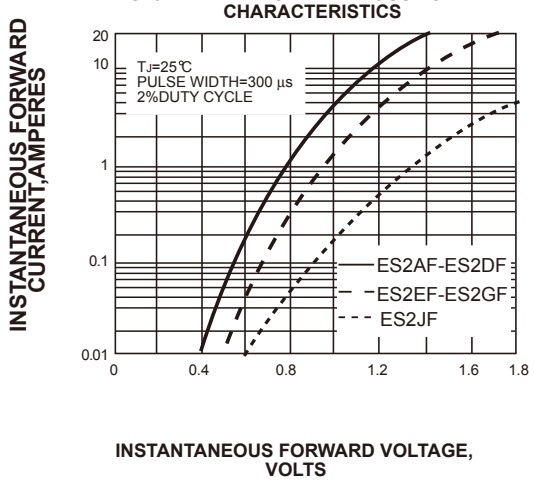


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

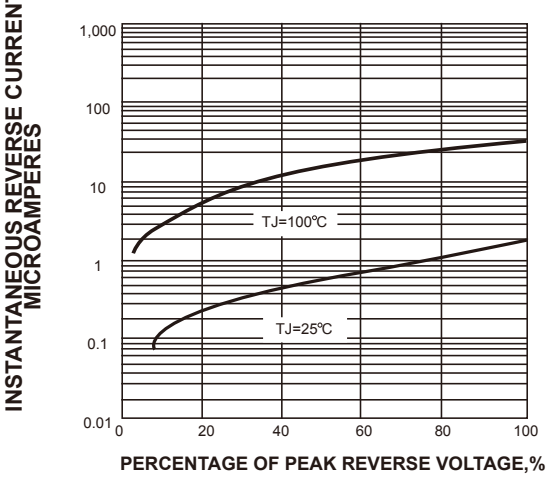


FIG. 5-TYPICAL JUNCTION CAPACITANCE

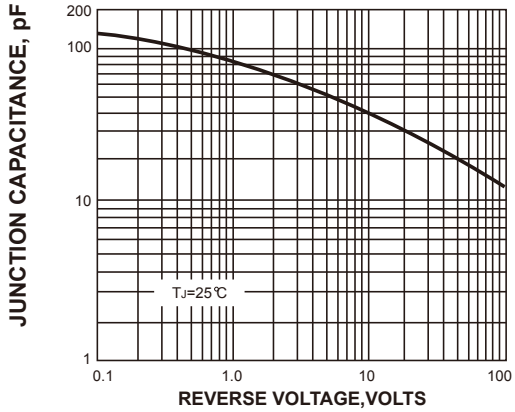


FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE